

# SID

Factory: Rot am See

Article:

672

ML6

Provided:

Stockburger, Olesja

Customer:

Date:

25.01.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-070my 330x490mm	50200246	70	VS	1	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	400		2	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		4	
C-RS-FR4-ML-0.71mm-105+105-TG150-HF	50200961	105	L2	5	A01
		710			
		105	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	50		6	B00
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	170		7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		8	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	50		9	
C-RS-FR4-ML-0.71mm-105+105-TG150-HF	50200961	105	L4	10	A02
		710			
		105	L5		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	400		11	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		12	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		13	
A-RS Kupferfolie-070my 330x490mm	50200246	70	RS	14	

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

3050 µm

Version 1.2.14.15

© Würth Elektronik